

Variable Capacitance Diode

Description

The 1T403 is a variable capacitance diode designed for electronic tuning of VHF TV tuners and CATV tuners using a super-small-miniature flat package (SSVC).

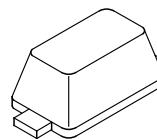
Features

- Super-small-miniature flat package
- Low series resistance: 0.8 Ω Max. (f=470 MHz)
- Large capacitance ratio: 15.0 Typ. (C_1/C_{28})
- Small leakage current: 10 nA Max. ($V_R=28$ V)
- Capacitance deviation in a matching group:
within 2 %

Applications

Electronic tuning of TV and CATV tuners

M-290



Absolute Maximum Ratings (Ta=25 °C)

- | | | | |
|-------------------------|-----------|-------------|----|
| • Reverse voltage | V_R | 30 | V |
| • Peak reverse voltage | V_{RM} | 35 | V |
| (RL≥10 kΩ) | | | |
| • Operating temperature | T_{opr} | -20 to +75 | °C |
| • Storage temperature | T_{stg} | -65 to +150 | °C |

Structure

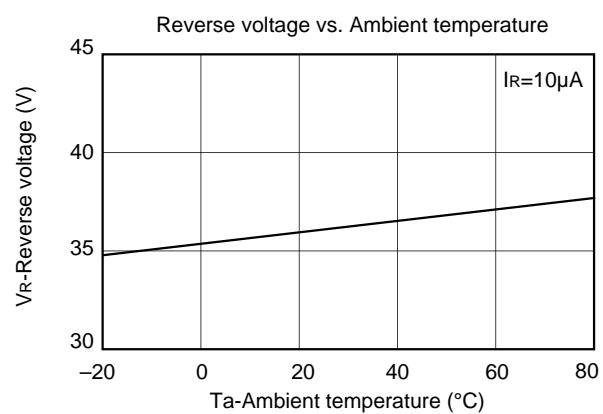
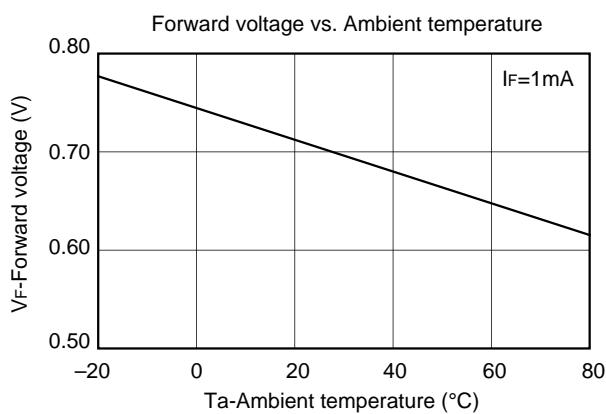
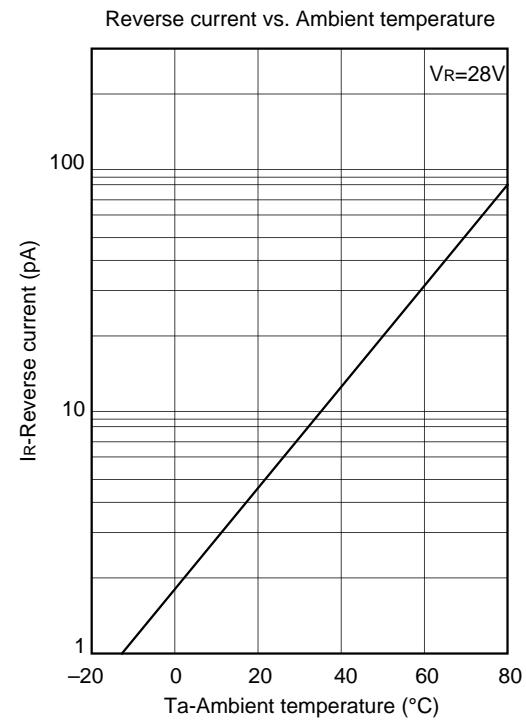
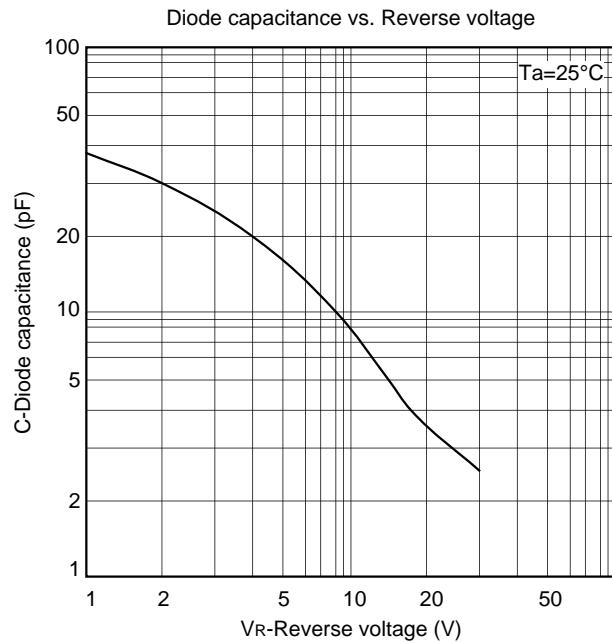
Silicon epitaxial planar type diode

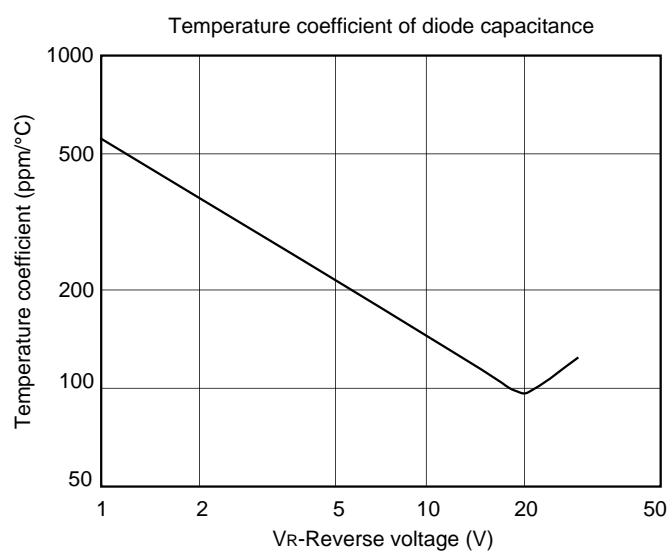
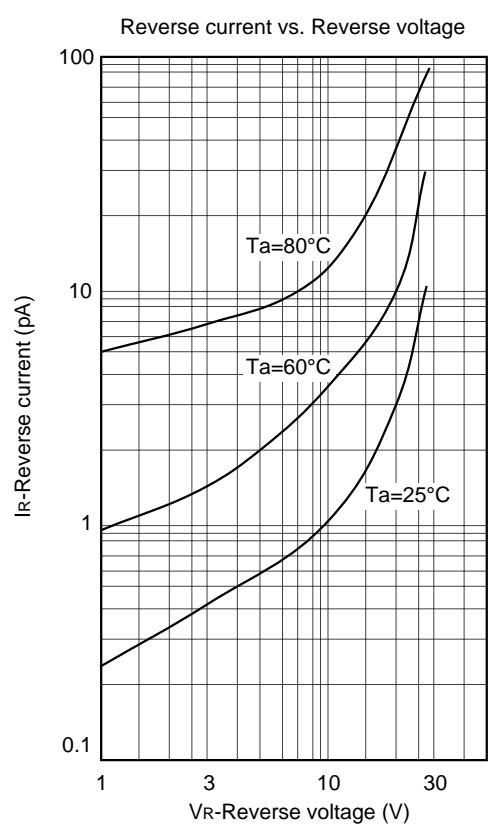
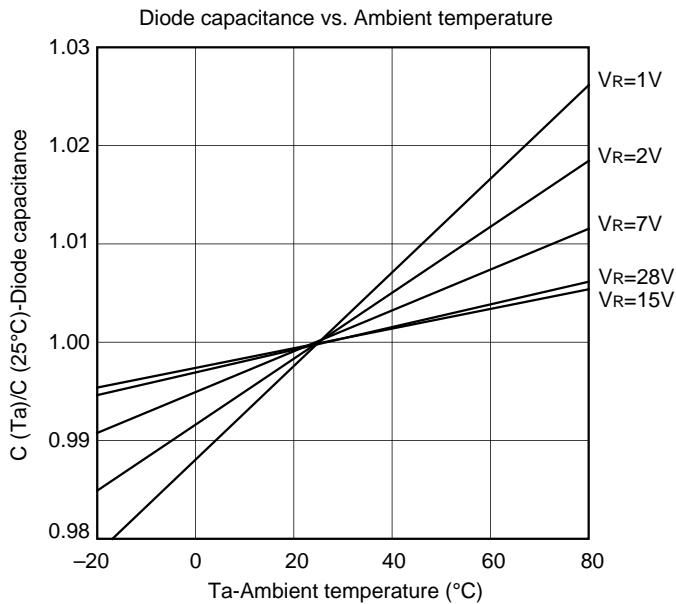
Electrical Characteristics

(Ta=25 °C)

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Reverse current	I_R	$V_R=28$ V			10	nA
Diode capacitance	C_1	$V_R=1$ V, f=1 MHz	34.61		42.31	pF
	C_{28}	$V_R=28$ V, f=1 MHz	2.321		2.714	pF
Capacitance ratio	C_1/C_{28}		13.5	15.0		
Series resistance	r_s	$C_D=14$ pF, f=470 MHz		0.75	0.80	Ω
Capacitance deviation in a matching group	ΔC	$V_R=1$ to 28 V, f=1 MHz			2	%

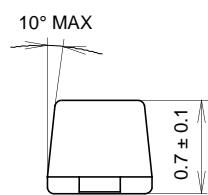
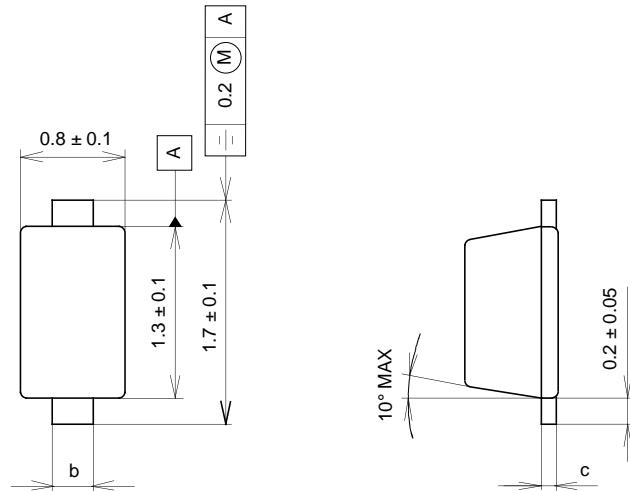
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Package Outline Unit : mm

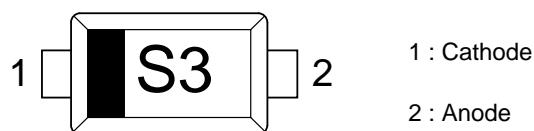
M-290



	BASE METAL	WITH PLATING
c	0.11 ± 0.005	$0.11^{+0.05}_{-0.01}$
b	0.3 ± 0.025	$0.3^{+0.05}_{-0.02}$

SONY CODE	M-290
EIAJ CODE	_____
JEDEC CODE	_____

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	COPPER
PACKAGE WEIGHT	0.002g

Mark

This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.